MOSFET - Power, Single, N-Channel

40 V, 0.67 mΩ, 370 A

NTMFS5C404NLT

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NTMFS5C404NLTWF Wettable Flank Option for Enhanced Optical Inspection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage			V_{GS}	±20	V
Continuous Drain		T _C = 25°C	I _D	370	Α
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		260	
Power Dissipation	State	T _C = 25°C	P _D	200	W
R _{θJC} (Note 1)		T _C = 100°C		100	
Continuous Drain		T _A = 25°C	I _D	52	Α
Current R _{0JA} (Notes 1, 2, 3)	Steady	T _A = 100°C	1	37	
Power Dissipation	State	T _A = 25°C	P _D	3.9	W
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.9	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to + 175	°C
Source Current (Body Diode)			I _S	191	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 38 A)			E _{AS}	907	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.75	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

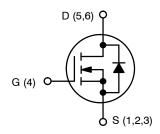
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	0.67 m Ω @ 10 V	070 4
40 V	1.0 mΩ @ 4.5 V	370 A

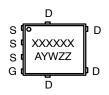


N-CHANNEL MOSFET

MARKING DIAGRAM



DFN5 (SO-8FL) CASE 506EZ



XXXXXX = 5C404L

(NTMFS5C404NLT) or

404LWF

(NTMFS5C404NLTWF) = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

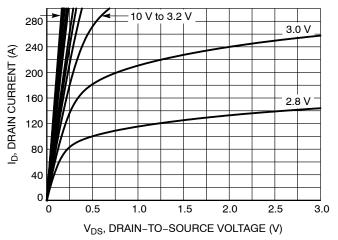
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				21.6		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	Vng = 40 V	T _J = 25 °C			10	_	
			T _J = 125°C			250	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$		1.2		2.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-6.2		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.52	0.67	0	
		V _{GS} = 4.5 V	I _D = 50 A		0.75	1.0	0 mΩ	
Forward Transconductance	9FS	V _{DS} =15 V, I _D = 50 A			270		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			12168			
Output Capacitance	Coss				4538		pF	
Reverse Transfer Capacitance	C _{RSS}				79.8			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 20 V; I _D = 50 A			81			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A			181		1	
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 20 V; I _D = 50 A			8.5		nC	
Gate-to-Source Charge	Q _{GS}				27.8			
Gate-to-Drain Charge	Q_{GD}				23.8			
Plateau Voltage	V_{GP}				2.7		V	
SWITCHING CHARACTERISTICS (Note 5	5)							
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 20 V, I_{D} = 50 A, R_{G} = 1.0 Ω			24		- ns	
Rise Time	t _r				135			
Turn-Off Delay Time	t _{d(OFF)}				87			
Fall Time	t _f				157			
DRAIN-SOURCE DIODE CHARACTERIS	TICS							
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V,	T _J = 25°C		0.7	1.2		
	$I_{S} = 50 \text{ A}$ $T_{J} = 125^{\circ}\text{C}$	0.61		V				
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, dIS/dt} = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 50 \text{ A}$			97.4			
Charge Time	ta				46.5		ns	
Discharge Time	t _b				50.9		1	
Reverse Recovery Charge	Q _{RR}				190		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

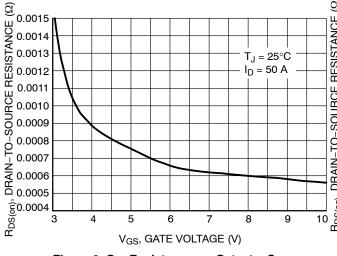
TYPICAL CHARACTERISTICS



800 700 ID, DRAIN CURRENT (A) 600 500 400 300 $T_J = 25^{\circ}C$ 200 $T_{J} = 125^{\circ}$ 100 $T_{.1} = -55^{\circ}C$ 0 0 0.5 2.0 3.0 3.5 1.0 1.5 2.5 V_{GS}, GATE-TO-SOURCE VOLTAGE (V)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



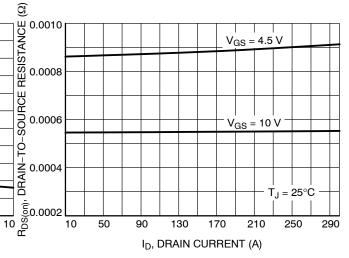
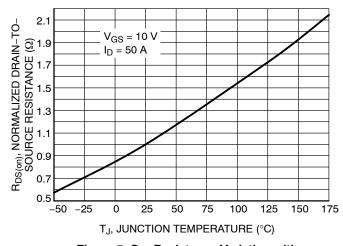


Figure 3. On-Resistance vs. Gate-to-Source Voltage

Figure 4. On-Resistance vs. Drain Current and Gate Voltage



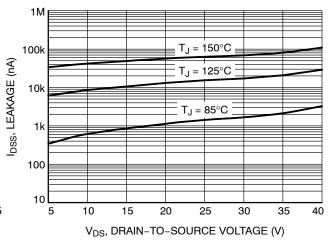
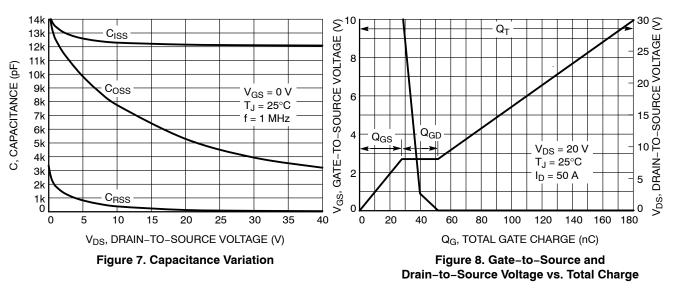


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



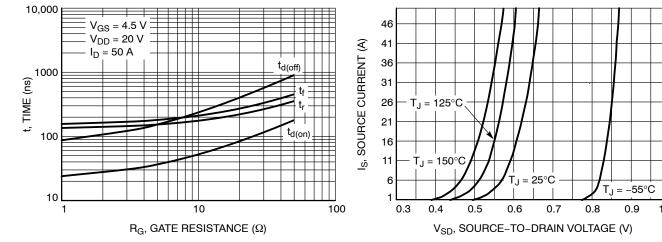


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current

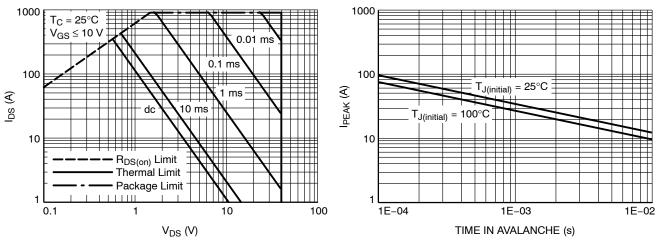


Figure 11. Safe Operating Area

Figure 12. I_{PEAK} vs. Time in Avalanche

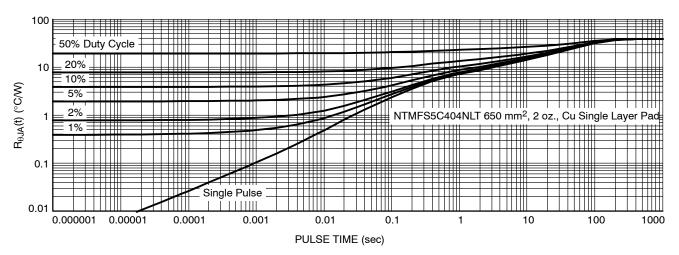


Figure 13. Thermal Characteristics

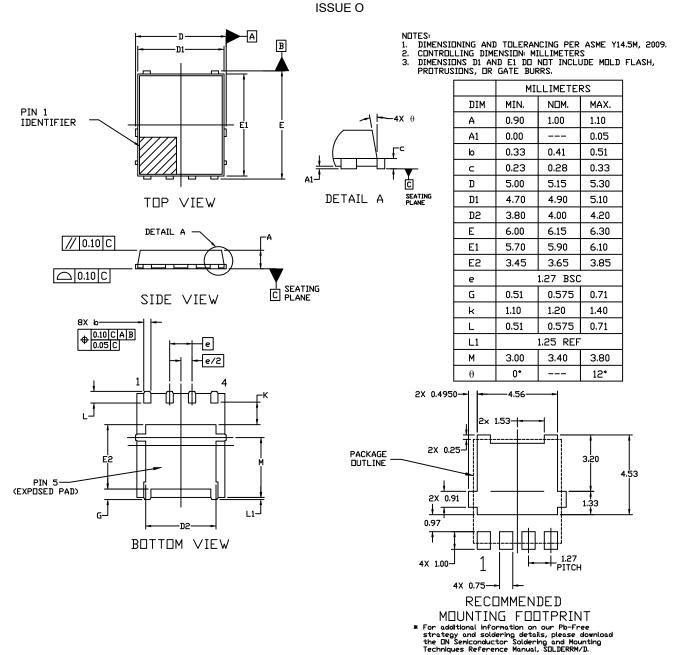
DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS5C404NLTT1G	5C404L	DFN5 (Pb-Free)	1500 / Tape & Reel
NTMFS5C404NLTWFT1G	404LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NTMFS5C404NLTT3G	5C404L	DFN5 (Pb-Free)	5000 / Tape & Reel
NTMFS5C404NLTWFT3G	404LWF	DFN5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

DFN5 5x6, 1.27P (SO-8FL) CASE 506EZ



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